



## Introduction and Motivation

### Power Electronics:

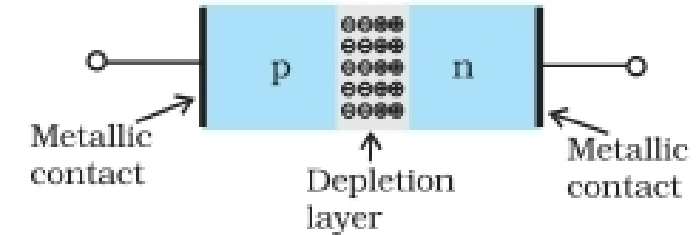
- Used to control and convert electric power, common in electronic consumer devices.
- Requires the use of high-efficiency, high-voltage transistors.
- AlGaN heterostructures have been used for PE designs for HEMT, RTDs, and more.
  - (Bayram et al., 2010)

### Ultra-wide-bandgap ( $E_{UV} \sim 3.1$ eV) Uses of AlGaN:

- Some aspects of diode performance can scale non-linear with increased band gap.
  - (Tsao et al., 2018)
- UV Light emitting diodes, photodetectors, ultra-fast “switch” for power electronics, high-temperature and high-power durability.
  - (Li et al., 2017; Lebedev, 1999; Hudgins et al., 2003; Chow, 1994)
- Amplifiers of high current electronic devices.

### AlGaN Based Surfaces and Interfaces:

- p-n Interface preferability
- Surface Metallicity
- Carbon interface influence and amorphization



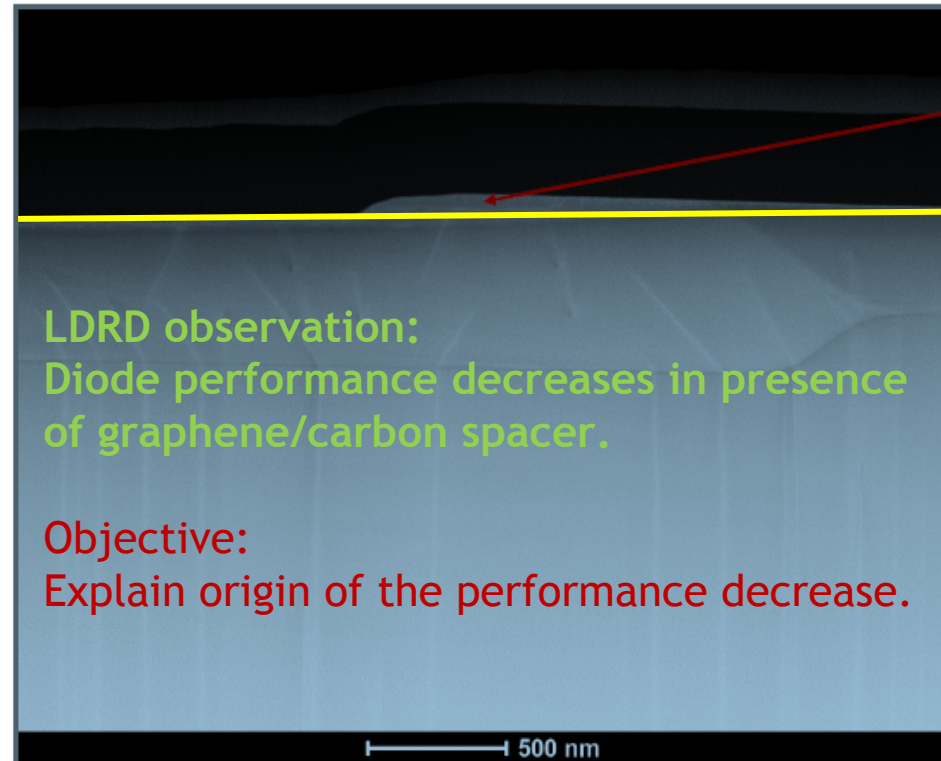
Semiconductor diode,  
(toppr.com)





## Introduction and Motivation:

### Experiment (LDRD)



### Theory

Mg-GaN

graphene/carbon "spacer".  
Mg-AlGaN.

Si-AlGaN

Diode  
Substrate

P-GaN

Regrown p-30%  
AlGaN

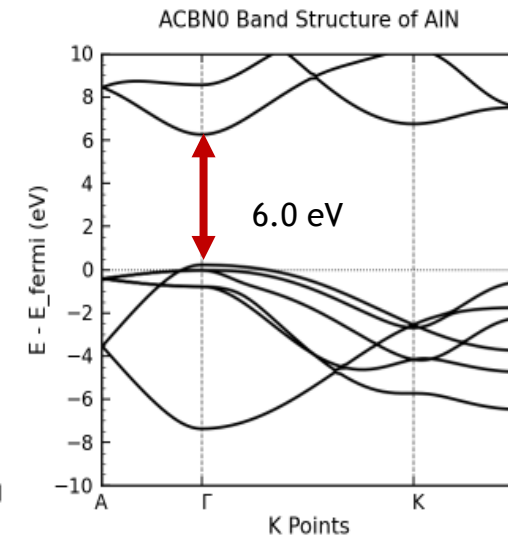
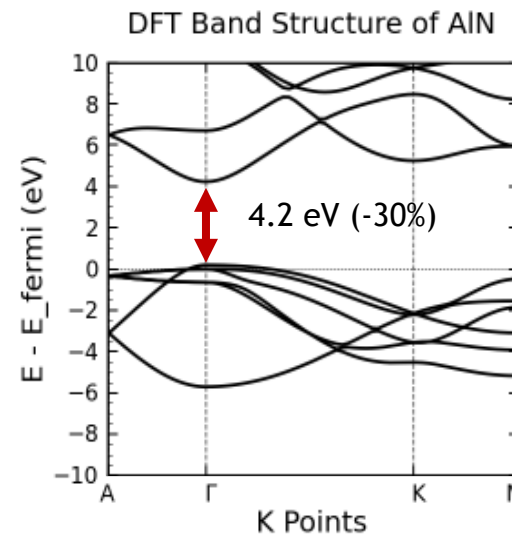
N- 31% AlGaN



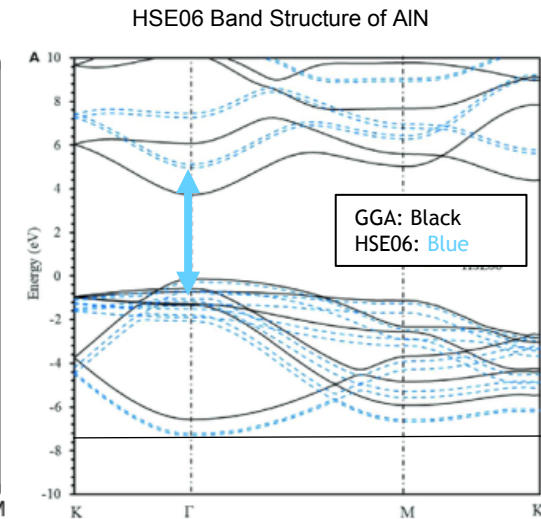
**Computational Approach:** All calculations were completed using Quantum Espresso Software Package (Giannozzi et al., 2017) .

- Density Functional Theory (DFT).
- Generalized gradient approximation.
  - (Perdew et al., 1996)
- DFT-like ACBN0 approach increases DFT band gaps.
  - (Agapito et al., 2015)
- Computations are largely optimized for an energy cutoff of 75 Ry, and K-point sampling of 6x6x4 for a bulk, 4-atom unit cell.
- $E_g$  converged to 0.02 eV

### This work



Exp.: 6.026 eV (Guo and Yoshida, 1994)



(Alsaad et al., 2020)

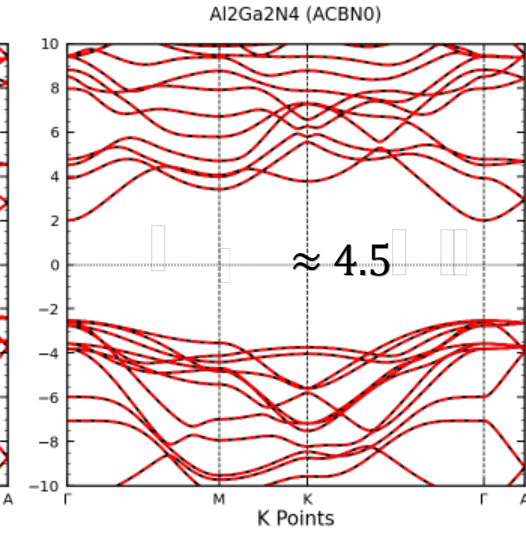
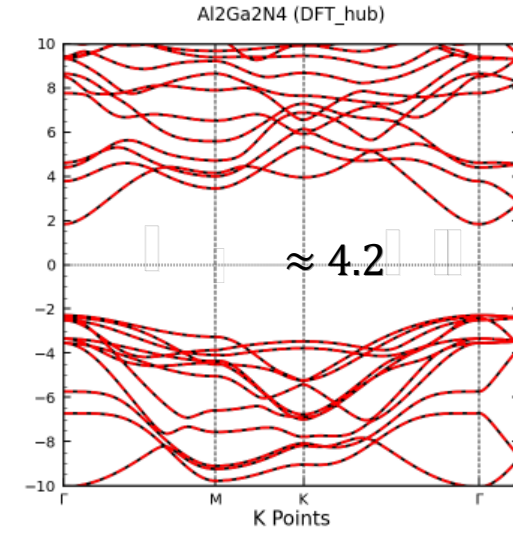
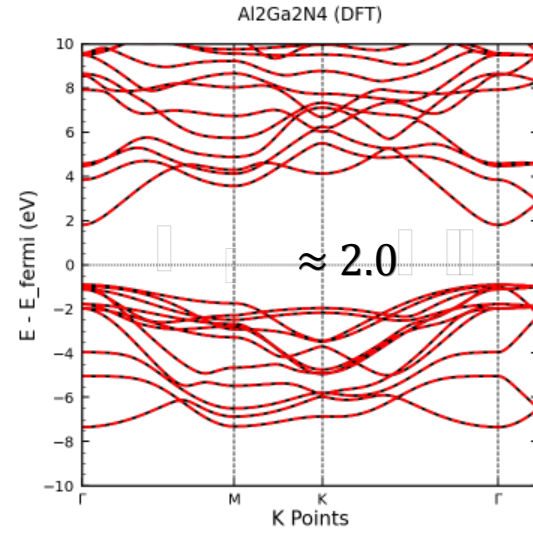
### Results:

- ACBN0 increases DFT bandgap as expected.
- Comparable to experiment and resource demanding HSE06 computations.



## Improving Reliability of ACBN0 Computations

	DFT_hub	Experiment
AlN	5.74 eV	6.2 eV (Yim et al., 1973)
GaN	3.19 eV	3.39 eV (Maruska, 1969)
AlGa <sub>N</sub>	4.18 eV	4.5 eV (Sang et al., 2013)

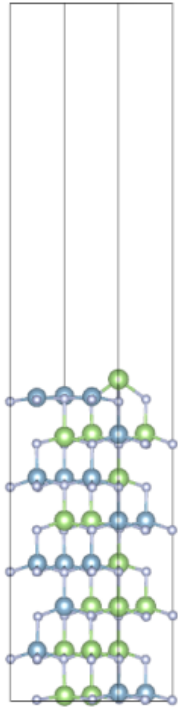


Thermochemistry	DFT	DFT	ACBN0
Electronic Structure	DFT	ACBN0	ACBN0

- New Process: DFT vc-relax → Add H-U Parameters → Band Structures **(without re-relaxing)**
- The new process relaxed structure sees a -1.4% deviation in the lattice parameters from true ACBN0.
- New process produces a similar band gap and does not require the unknown Hubbard-U parameters of required atomic species.



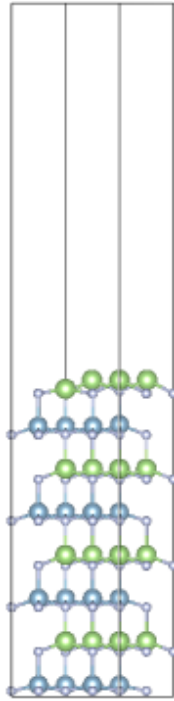
## Technical Accomplishments and Updates: Ordered vs Disordered



Disordered:

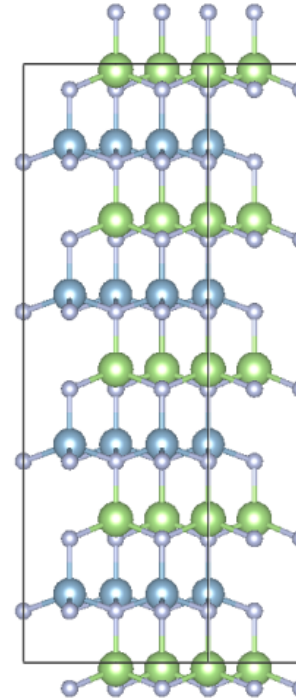
$$\Delta E = +7.29 \text{ meV/atom}$$

Same composition



Ordered:

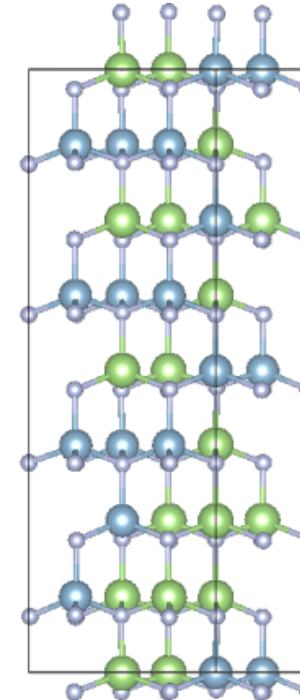
$$\Delta E = 0 \text{ eV/atom}$$



Disordered:

$$\Delta E = +3.4 \text{ meV/atom}$$

Same composition



Ordered:

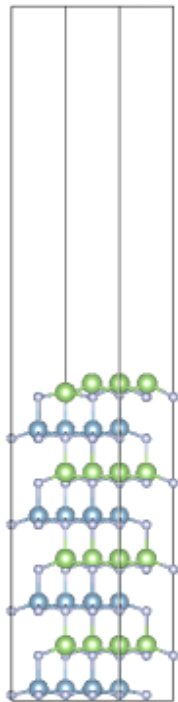
$$\Delta E = 0 \text{ eV/atom}$$

- Ga truncation is more energetically favorable than the Al truncations for surface calculations.
- Disordered AlGaN may perform better in strain-based scenarios due to the uniform strain distribution (Cheng et al., 2019).

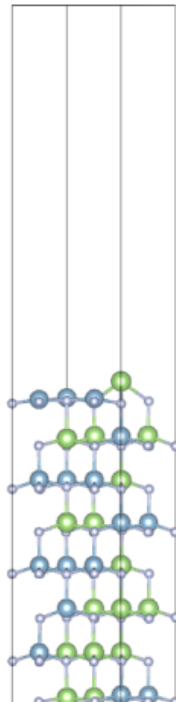
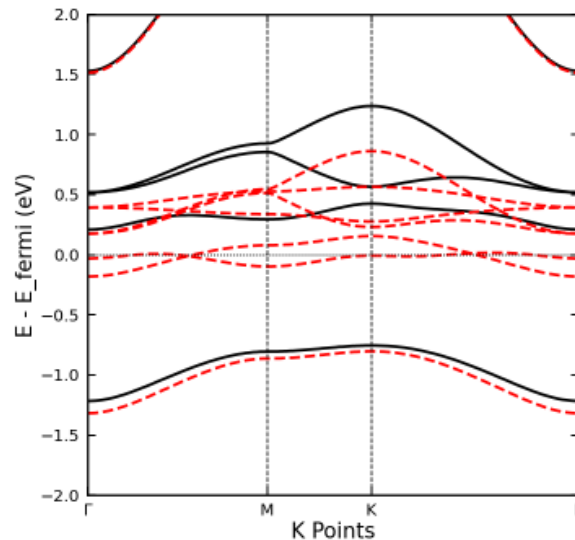
- Bulk and Disordered structures are energetically near generate,  $\Delta E < 25 \frac{\text{meV}}{\text{atom}}$ .



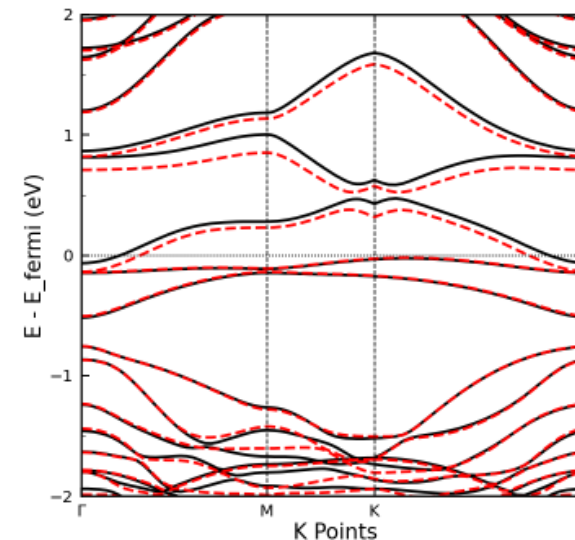
## Technical Accomplishments and Updates: Metallic surfaces



8-layer, 64-atom



8-layer, 64-atom



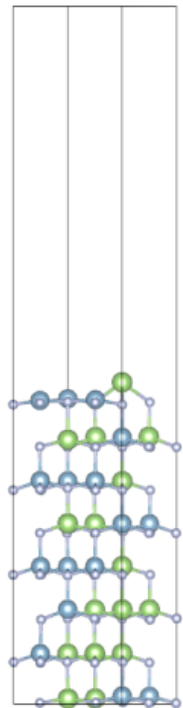
- Bulk AlGaN is a widegap material,  $E_g = 4.5 \text{ eV}$ .
- Many-layered AlGaN slabs are metallic, implying that creating interfaces would reduce diode performance.

- **Unbound electrons at surface are delocalized and conducting → Forming surfaces closes the bandgap.**
- **Forming an interface and filling the vacuum will create new bonds, reopening the bandgap.**

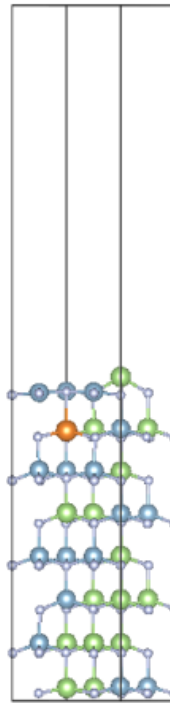
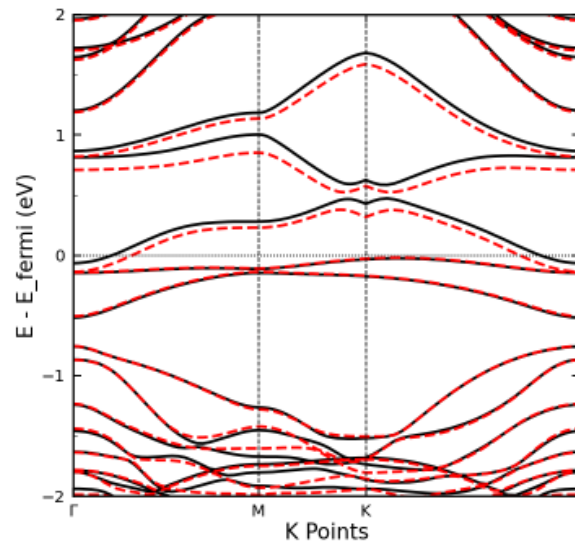
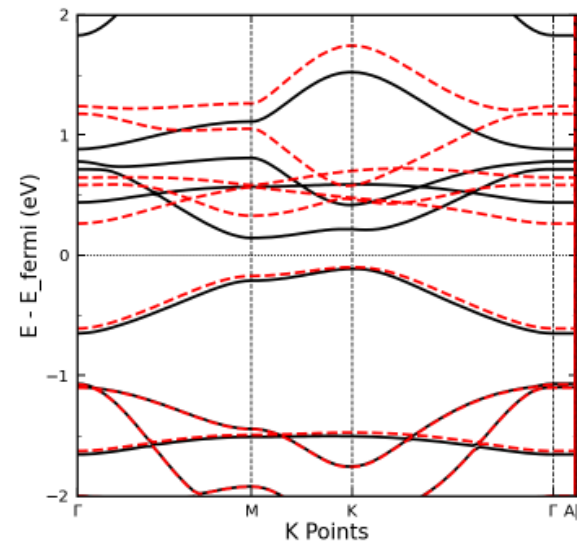




## Technical Accomplishments and Updates: Metallic surfaces



8-layer, 64-atom

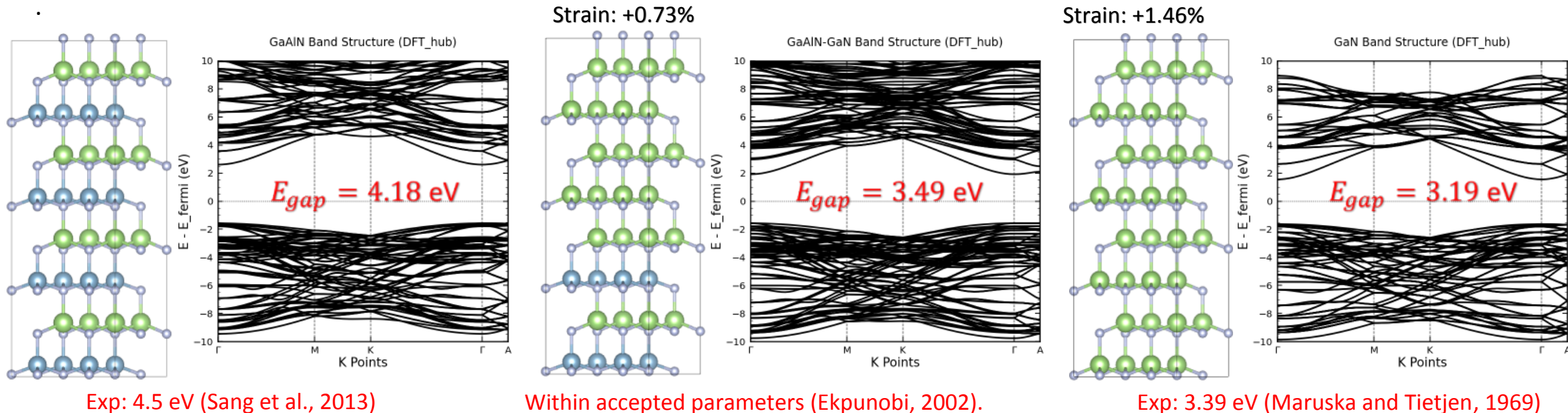
8-layer, 64-atom, Ga  $\rightarrow$  Mg

- Subsurface doping shows an opening of the band gap  
 $\rightarrow E_g = 0.24$  eV.
- Unbound orbitals along the surface may partially fill p-type electron hole.
- $\Delta E_{form} = -86$  meV from next most favorable dopant location.

- Electron conducting diodes may see increased performance by countering with electron holes.
- Hole + electron  $\rightarrow$  p-n heterojunctions are predicted to perform well.

## Technical Accomplishments and Updates: Insulating Interfaces

- At this point that we shifted our attention to the experimental interfaces developed by the LDRD team.
- Computational methods resolve average CBM for AlGaN, GaN, and AlGaN/GaN  $\sim 2.0$  eV, agreeing with experiment (Kim et al., 2019)



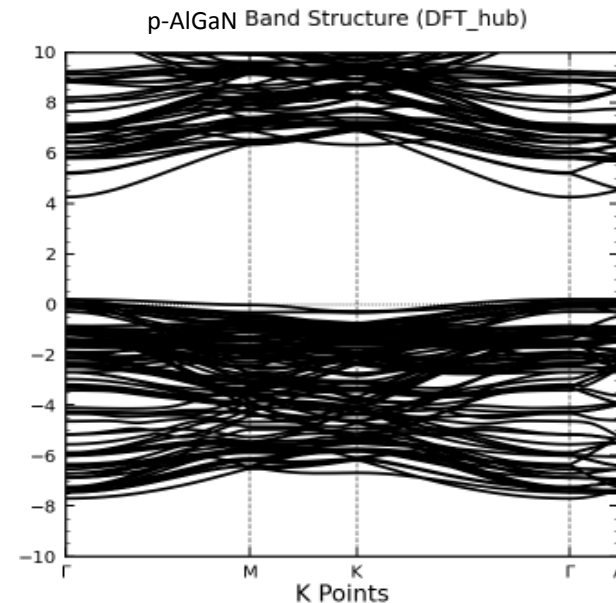
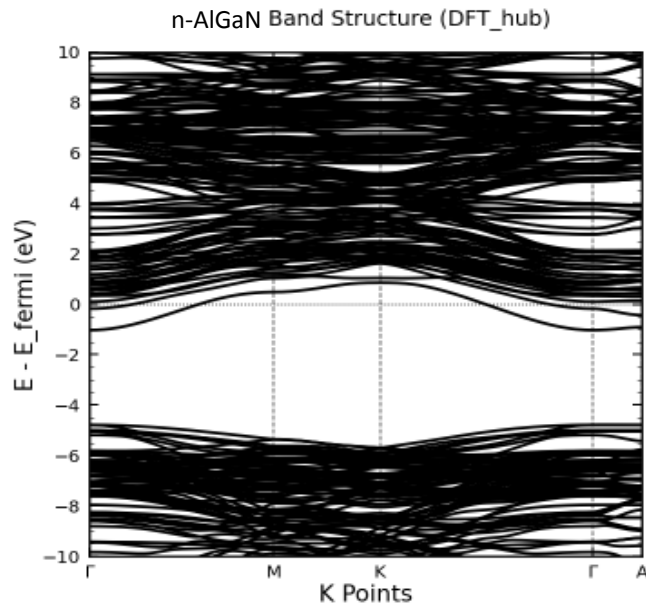
- **Results: Closing the gap above a surface will fill the open orbitals, recreating an insulating material.**
- **The heterostructure gap is noticeably near the average of the two separate bulk structures.**





### Technical Accomplishments and Updates: n-AlGaIn/p-AlGaIn Interface Favorability

- The focus was on three diode compositions: p-AlGaIn/p-GaN, AlGaIn/p-GaN, and **p-AlGaIn/n-AlGaIn** (Carbon omitted for computation).
- Due to the extra electrons in p-type heterojunctions, p-AlGaIn/p-GaN and AlGaIn/p-GaN interfaces are localized hole conductors, leading to endothermic alloying energies and a metallic band gap.
- n-AlGaIn/p-AlGaIn heterostructures are computed as widegap insulators, suitable for diode production.



- n-AlGaIn: Conduction band metallic,  $E_{gap} = N/A$ .
- p-AlGaIn: Valence band metallic,  $E_{gap} = 4.06 \text{ eV}$ .
- Mg-doping shifts VBM upwards as expected.
  - (Li and Kang, 2007)

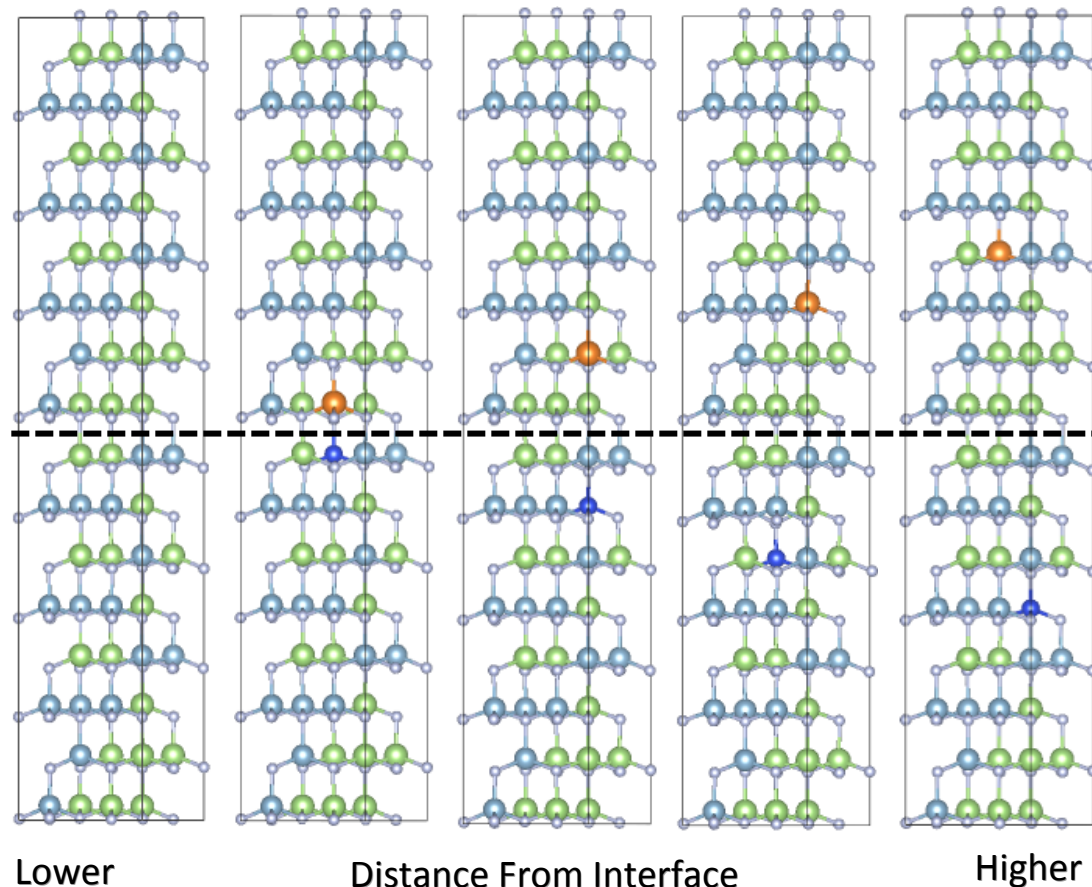
**Expectation:**

**n-type electron donor + p-type electron hole**

**→ Insulating heterostructure**



## Technical Accomplishments and Updates: n-AlGa<sub>N</sub>/p-AlGa<sub>N</sub> Interfaces



### Distance Dependence

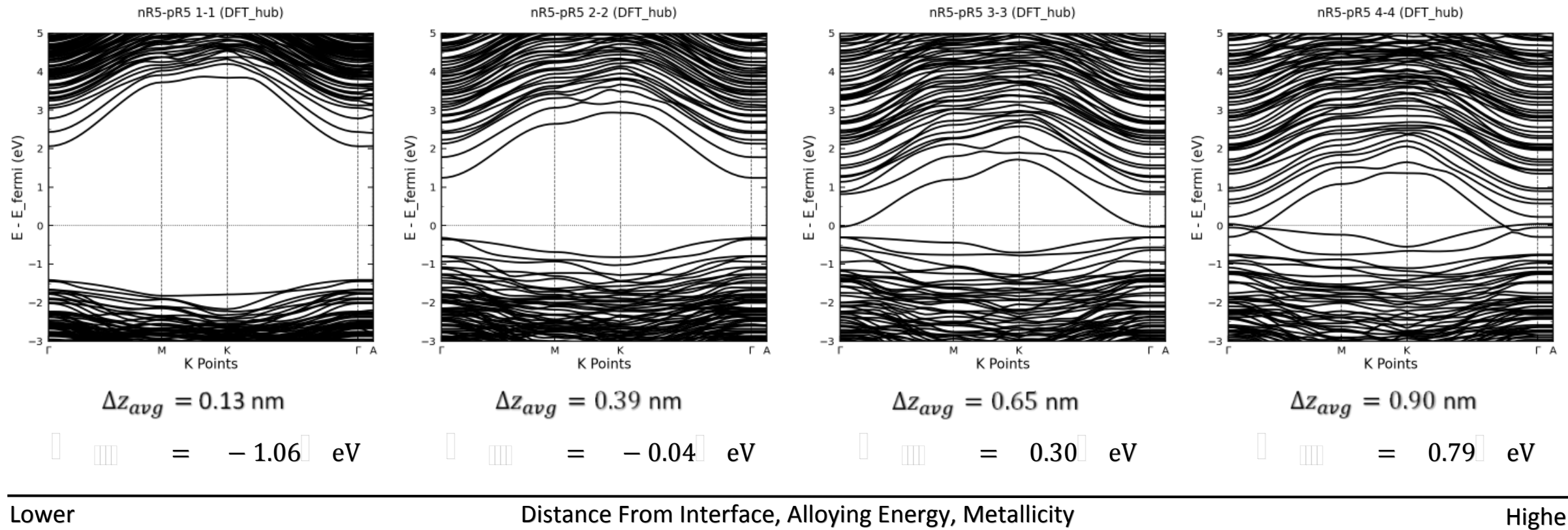
Distance From Interface	Alloying Energy	Fundamental Gap
$\Delta Z_{Average} = 0.13 \text{ nm}$	-1.059 eV	3.472 eV
$\Delta Z_{Average} = 0.39 \text{ nm}$	-0.036 eV	1.556 eV
$\Delta Z_{Average} = 0.65 \text{ nm}$	0.302 eV	Metallic
$\Delta Z_{Average} = 0.90 \text{ nm}$	0.788 eV	Metallic
AlGa <sub>N</sub> (Undoped)	$E_g = 4.242 \text{ eV}$	

- Hole + electron creates insulating material in agreement with similar p-n band offsets.
  - (Lang et al., 1987)
- Coulomb interactions and strain overlap may increase band gaps and decrease alloying energies.
- **Dopants accumulate near the interfaces; near interface doping may increase diode performance.**





## Technical Accomplishments and Updates: n-AlGaIn/p-AlGaIn Interfaces

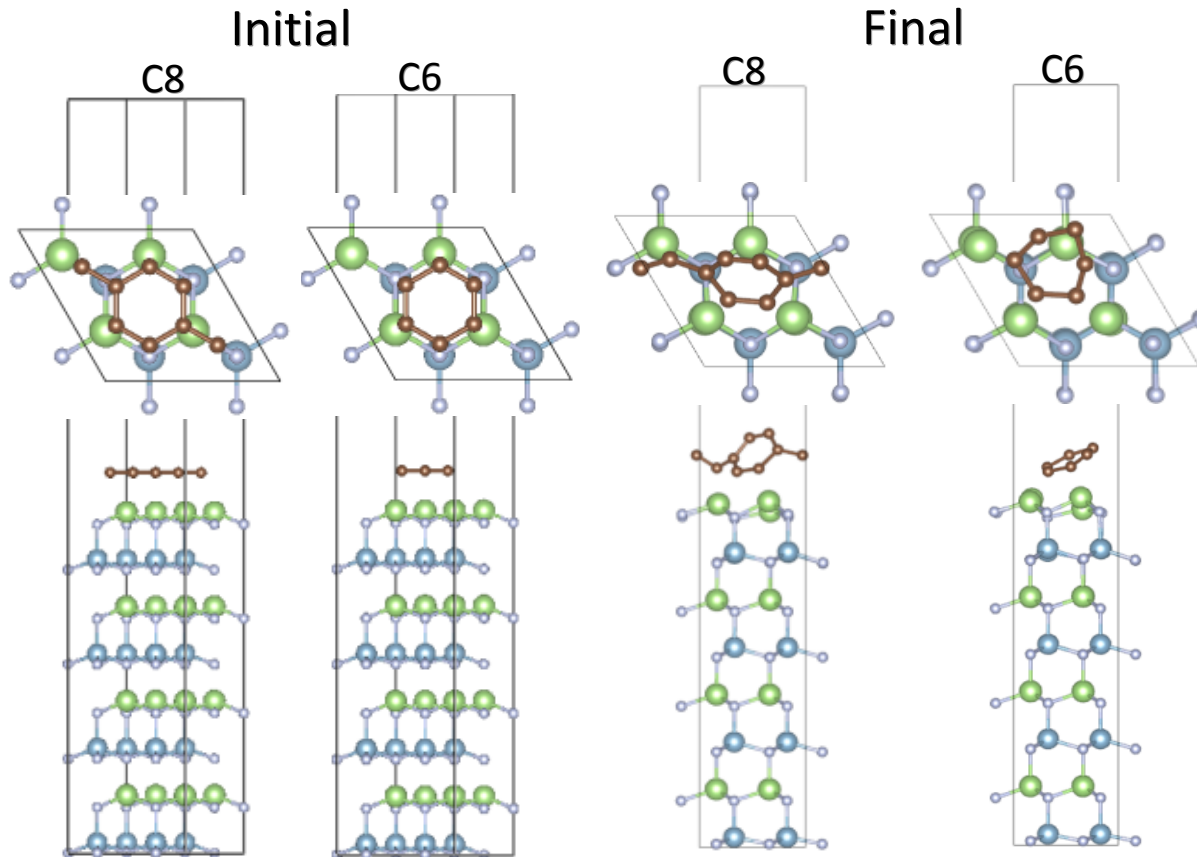






## Technical Accomplishments and Updates: Metallic Surfaces with Carbon, Carbon Amorphization

- First attempts at introducing carbon to an **Ordered** AlGaN interface:



Std Dev. Initial C-C Graphene bonds: 0.001 (Å)

	C8: Std Dev.	C6: Std Dev
Undoped	0.078 (Å)	0.050 (Å)
Doped	0.076 (Å)	0.069 (Å)

Insights:

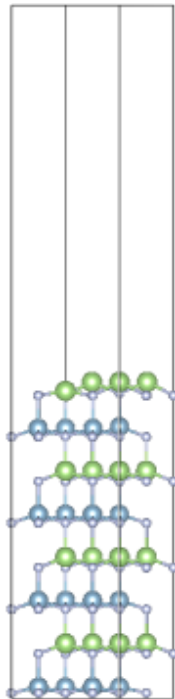
- 8-atom and 6-atom carbon molecules both appear to be amorphous.
- Carbon molecules experience torque.
- Testing included p-doped surfaces.

**Conclusion:**

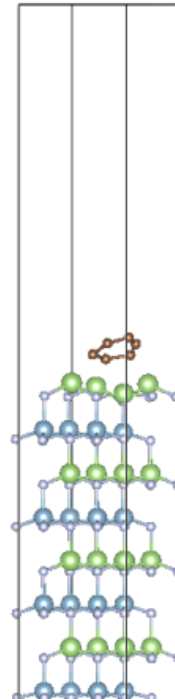
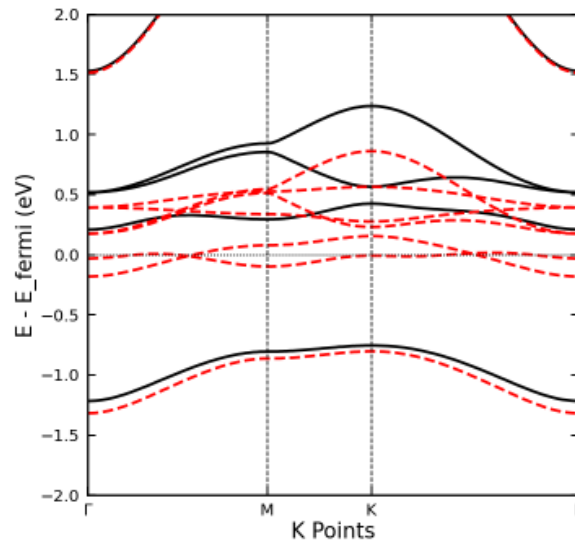
**C-C edges may cause amorphization at ordered AlGaN surfaces/interfaces, independent of doping.**



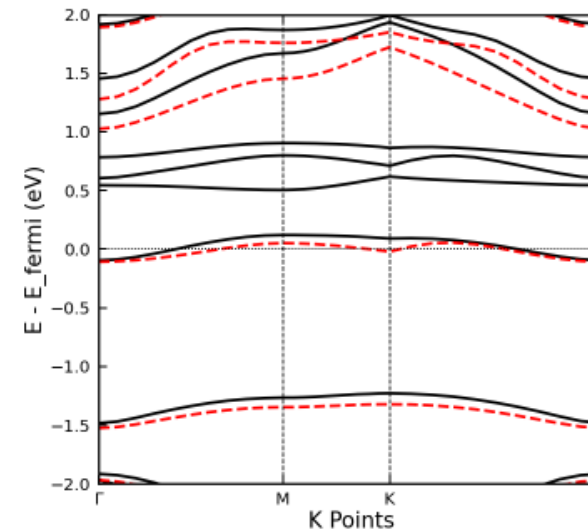
## Technical Accomplishments and Updates: Effect of C6 ring of Ordered AlGa<sub>N</sub>



8-layer, 64-atom AlGa<sub>N</sub>



AlGa<sub>N</sub>/C6 Surface



- The carbon spacer does little to mediate the metallicity of the surfaces.
- Carbon induces slight amorphization in AlGa<sub>N</sub> substrate, likely due to sp<sup>2</sup> carbon orbitals.

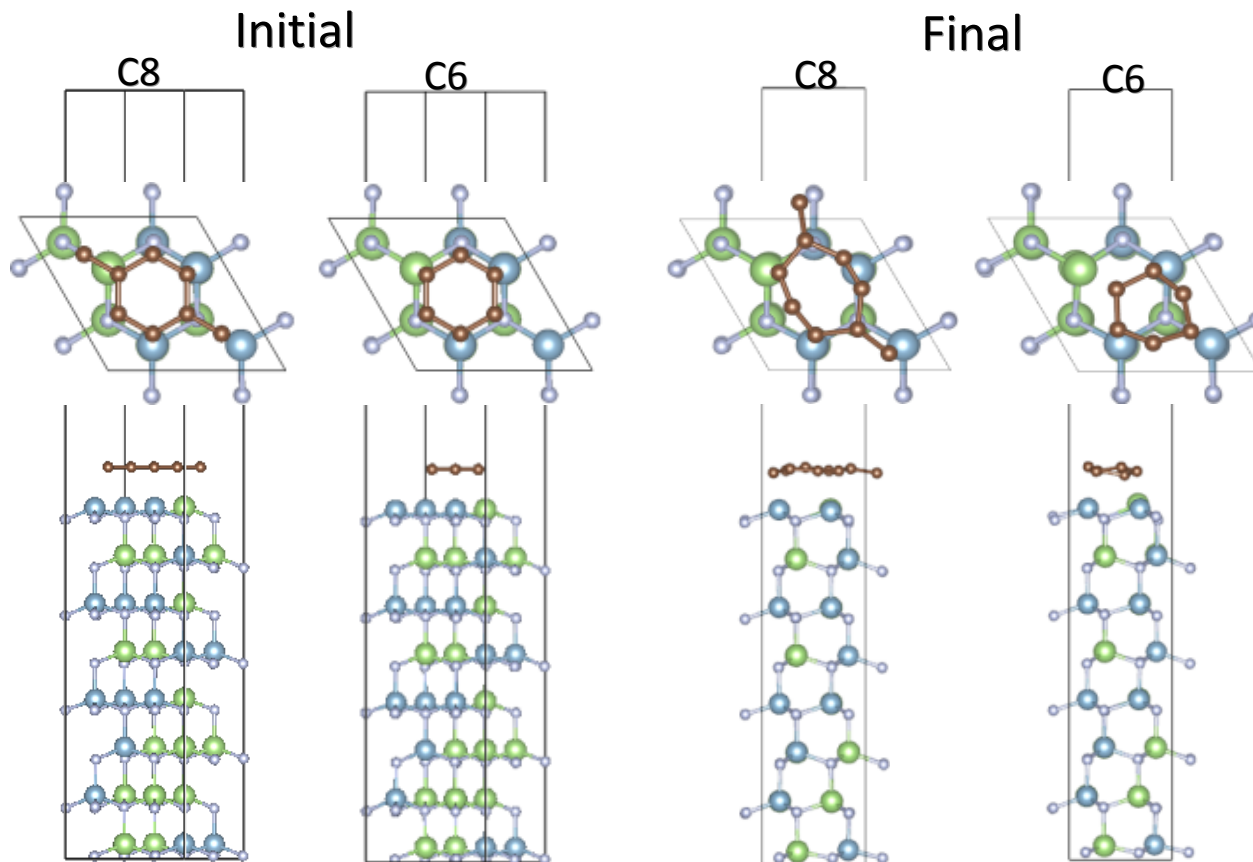
- Carbon molecules interact with the substrate, changing the density of near-fermi level bands
- Carbon does not affect metallicity or increase diode performance.



## Technical Accomplishments and Updates: Metallic Surfaces with Carbon, Carbon Amorphization

- First attempts at introducing carbon to a **Disordered** AlGaIn interface:

Std Dev. Initial C-C Graphene bonds: 0.001 (Å)



	C8: Std Dev.	C6: Std Dev
Undoped	0.096 (Å)	0.051 (Å)
Doped	0.074 (Å)	0.065 (Å)

### Insights:

- 8-atom and 6-atom carbon molecules appear to be amorphous and experience a torque.
- Disordered distributions see reduced z-axis buckling.

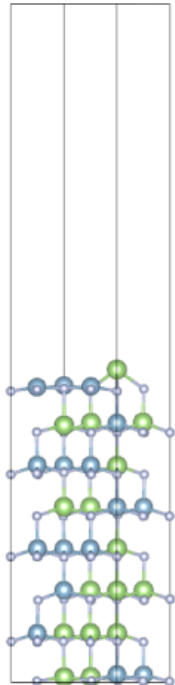
### Conclusion:

**C-C edges may induce amorphization, amorphization is relatively consistent between ordered and disordered AlGaIn.**

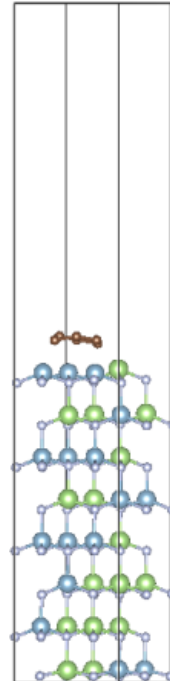
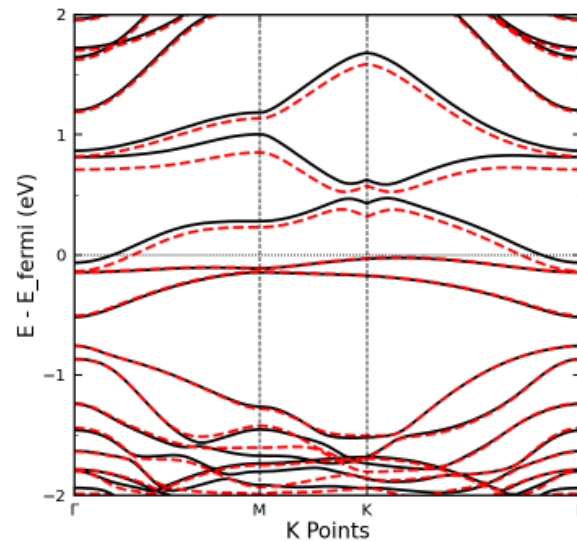




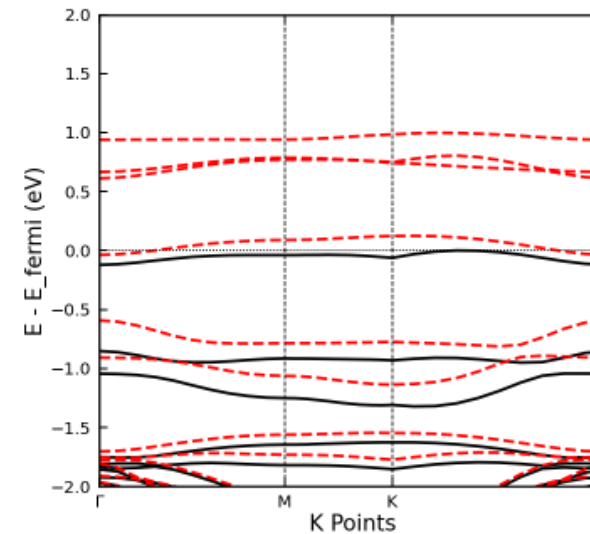
## Technical Accomplishments and Updates: Effect of C6 ring of Disordered AlGaN



8-layer, 64-atom



AlGaN/C6 Surface



- The carbon spacer does little to mediate the metallicity of the surfaces.
- Disordered substrate is more uniform than ordered substrate, likely due to uniform strain distribution.

- **Carbon molecules interact with the substrate, changing the density of near-fermi level bands**
- **Carbon does not affect metallicity or increase diode performance.**



### Conclusions:

- Devices based on AlGaN, GaN or their interfaces show great potential for high-power, high-temperature, and high-frequency power electronics due to the nature of wide-band gap semiconductors.
- Enhanced the widely used Density Functional Theory computational method using ACBN0 to increase the accuracy of our calculated electronic properties of wide gap semiconductors.
- Our results show bulk AlGaN is a good insulator, AlGaN surfaces destroy diode insulation.
- Non-metallic p-AlGaN (disordered) surface suggest localized hole-conductors, and uniform strain distribution reopening the band-gap.
- p-n AlGaN diodes are promising → hole + electron conduction open band gap, dopants accumulate near interface.
- Localized carbon molecules have a benign effect on the electronic properties of AlGaN substrates.
- Carbon becomes amorphous, roughly 50x that of unperturbed graphene, strongly suggesting that C-C edges induce amorphization.